DATA SHEET

74ALS257/74ALS258
Data selector/multiplexer

Product specification
IC05 Data Handbook

1991 Feb 08

Philips
Semiconductors

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Data selector/multiplexer 74ALS257/74ALS258

74ALS257 Quad 2-input data selector, non-inverting (3-State)
74ALS258 Quad 2-input data selector, inverting (3-State)

DESCRIPTION

The 74ALS257 is a quad 2-input multiplexer which selects 4 bits of data from one of two sources under the control of a common select input (S). The output enable input ($\overline{OE}$) is active when Low. When $\overline{OE}$ is High, all of the outputs (Yn) are forced to a High impedance state (3-State) regardless of all other input conditions.

Moving data from two registers to a common output bus is a typical use of the 74ALS257. The state of the select input determines the particular register from which data comes.

The device is the logic implementation of 4-pole, 2-position switch where the position of the switch is determined by the logic levels supplied to the select input. The 74ALS258 is similar but has inverting outputs ($\overline{Y}$n).

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74ALS257	7.0ns	7mA
74ALS258	7.0ns	7mA

ORDERING INFORMATION

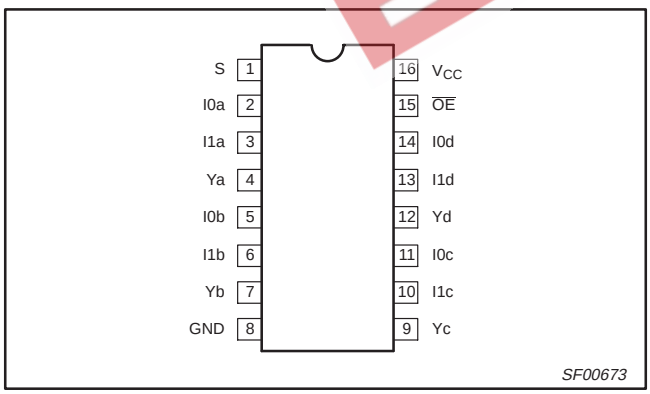
DESCRIPTION	ORDER CODE	DRAWING NUMBER
	COMMERCIAL RANGE V_{CC} = 5V ±10%, T_{amb} = 0°C to +70°C	
16-pin plastic DIP	74ALS257N, 74ALS258	SOT38-4
16-pin plastic SO	74ALS257D, 74ALS258D	SOT109-1
16-pin plastic SSOP Type II	74ALS257DB, 74ALS258DB	SOT338-1

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

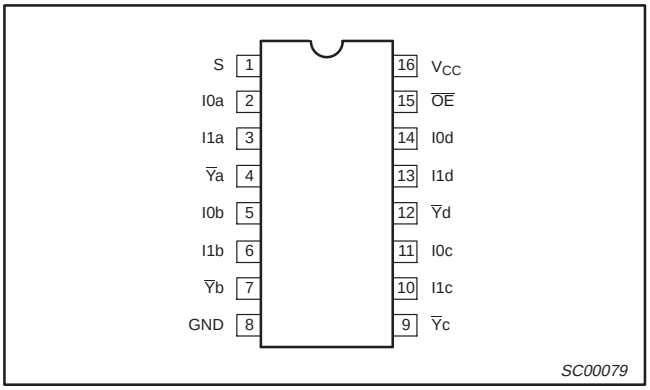
PINS	DESCRIPTION	74ALS (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
Ina, Inb, Inc, Ind	Data inputs	1.0/1.0	20µA/0.1mA
S	Select input	1.0/1.0	20µA/0.1mA
$\overline{OE}$	Enable input	1.0/1.0	20µA/0.1mA
Ya – Yd, $\overline{Y}$a – $\overline{Y}$d	Data outputs	20/240	0.4mA/24mA

NOTE: One (1.0) ALS unit load is defined as: 20µA in the High state and 0.1mA in the Low state.

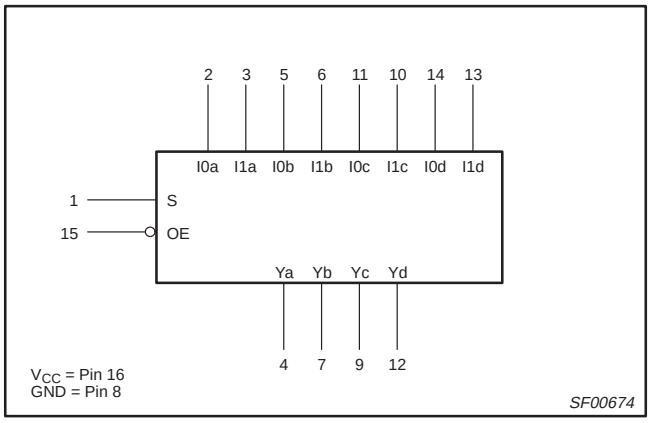
PIN CONFIGURATION – 74ALS257



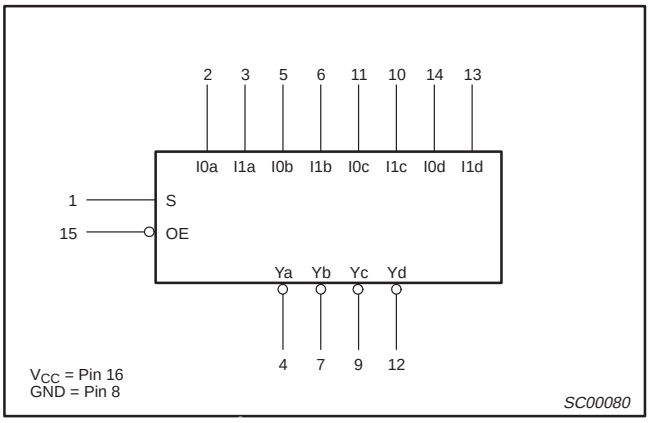
PIN CONFIGURATION – 74ALS258



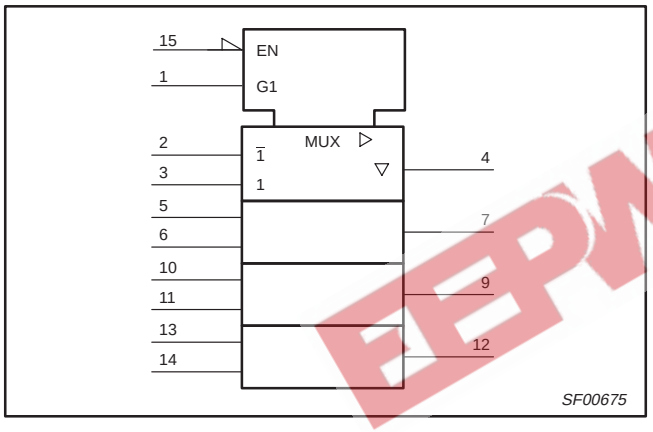
LOGIC SYMBOL – 74ALS257



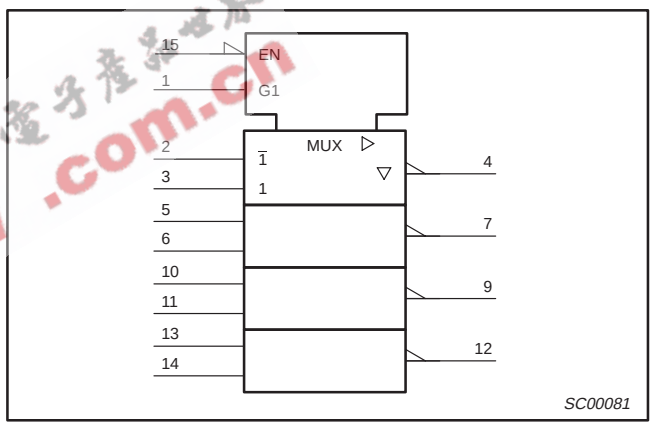
LOGIC SYMBOL – 74ALS258



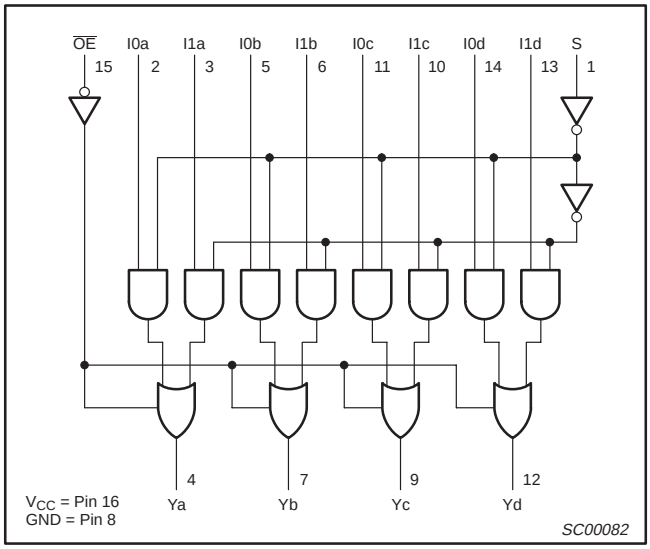
IEC/IEEE SYMBOL – 74ALS257



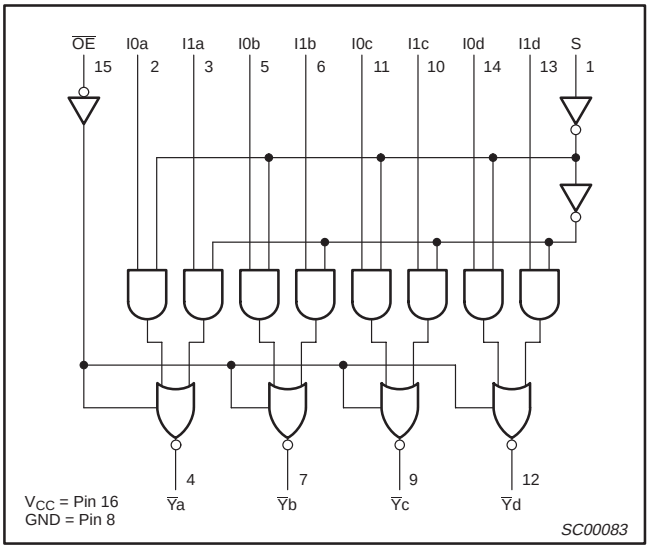
IEC/IEEE SYMBOL – 74ALS258



LOGIC DIAGRAM – 74ALS257



LOGIC DIAGRAM – 74ALS258



FUNCTION TABLE – 74ALS257

INPUTS				OUTPUT
$\overline{OE}$	S	I0n	I1n	Yn
H	X	X	X	Z
L	L	L	X	L
L	L	H	X	H
L	H	X	L	L
L	H	X	H	H

H = High voltage level
L = Low voltage level
X = Don't care
Z = High impedance "off" state

FUNCTION TABLE – 74ALS258

INPUTS				OUTPUT
$\overline{OE}$	S	I0n	I1n	$\overline{Y}$n
H	X	X	X	Z
L	L	L	X	H
L	L	H	X	L
L	H	X	L	H
L	H	X	H	L

H = High voltage level
L = Low voltage level
X = Don't care
Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V_{CC}	Supply voltage	–0.5 to +7.0	V
V_{IN}	Input voltage	–0.5 to +7.0	V
I_{IN}	Input current	–30 to +5	mA
V_{OUT}	Voltage applied to output in High output state	–0.5 to V_{CC}	V
I_{OUT}	Current applied to output in Low output state	48	mA
T_{amb}	Operating free-air temperature range	0 to +70	°C
T_{stg}	Storage temperature range	–65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS			UNIT
		MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5.0	5.5	V
V_{IH}	High-level input voltage	2.0			V
V_{IL}	Low-level input voltage			0.8	V
I_{IK}	Input clamp current			–18	mA
I_{OH}	High-level output current			–2.6	mA
I_{OL}	Low-level output current			24	mA
T_{amb}	Operating free-air temperature range	0		+70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER	TEST CONDITIONS[1]		LIMITS			UNIT
				MIN	TYP[2]	MAX	
V_{OH}	High-level output voltage	V_{CC} = ±10%, V_{IL} = MAX, V_{IH} = MIN	I_{OH} = –0.4mA	V_{CC} – 2			V
			I_{OH} = MAX	2.4	3.2		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN	I_{OL} = 12mA		0.25	0.40	V
			I_{OL} = 24mA		0.35	0.50	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = I_{IK}			–0.73	–1.5	V
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 7.0V				0.1	mA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.7V				20	µA
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.4V				–0.1	mA
I_{OZH}	Off-state output current, High-level voltage applied	V_{CC} = MAX, V_I = 2.7V				20	µA
I_{OZL}	Off-state output current, Low-level voltage applied	V_{CC} = MAX, V_I = 0.4V				–20	µA
I_O	Output current[3]	V_{CC} = MAX, V_O = 2.25V		–30		–112	mA
I_{CC}	Supply current (total)	74ALS257	I_{CCH}	V_{CC} = MAX		3	6	mA
			I_{CCL}			8	12	mA
			I_{CCZ}			9	14	mA
		74ALS258	I_{CCH}	V_{CC} = MAX		2.5	4	mA
			I_{CCL}			7	11	mA
			I_{CCZ}			9	13	mA

NOTES:

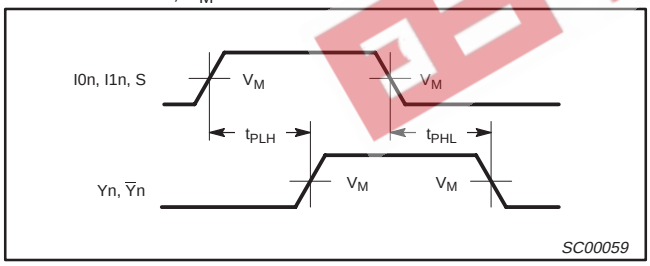
1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
2. All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
3. The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

AC ELECTRICAL CHARACTERISTICS

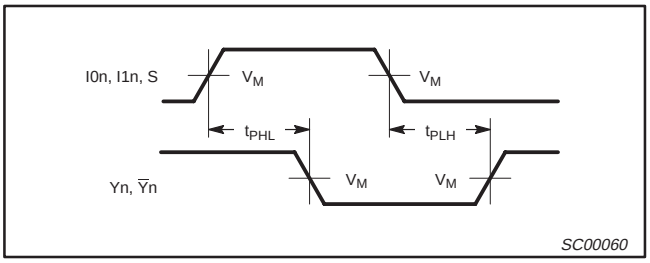
SYMBOL	PARAMETER		TEST CONDITION	LIMITS T_{amb} = 0°C to +70°C, V_{CC} = +5.0V ± 10%, C_L = 50pF, R_L = 500Ω		UNIT
				MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay I0n or I1n to Yn	74ALS257	Waveform 1	2.0 2.0	9.0 9.0	ns
t_{PLH} t_{PHL}	Propagation delay S to Yn		Waveform 1, 2	4.0 4.0	12.0 12.0	ns
t_{PZH} t_{PZL}	Output enable time $\overline{OE}$ to Yn		Waveform 3 Waveform 4	3.0 4.0	11.0 12.0	ns
t_{PHZ} t_{PLZ}	Output disable time $\overline{OE}$ to Yn		Waveform 3 Waveform 4	2.0 5.0	9.0 12.0	ns
t_{PLH} t_{PHL}	Propagation delay I0n or I1n to $\overline{Y}$n	74ALS258	Waveform 1	2.0 2.0	8.0 8.0	ns
t_{PLH} t_{PHL}	Propagation delay S to $\overline{Y}$n		Waveform 1, 2	4.0 4.0	12.0 12.0	ns
t_{PZH} t_{PZL}	Output enable time $\overline{OE}$ to Yn		Waveform 3 Waveform 4	3.0 4.0	11.0 12.0	ns
t_{PHZ} t_{PLZ}	Output disable time $\overline{OE}$ to $\overline{Y}$n		Waveform 3 Waveform 4	2.0 5.0	9.0 12.0	ns

AC WAVEFORMS

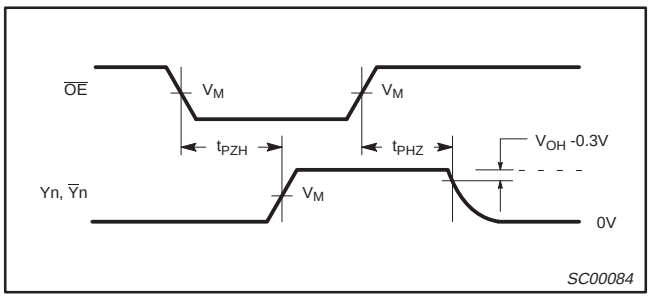
For all waveforms, V_M = 1.3V.



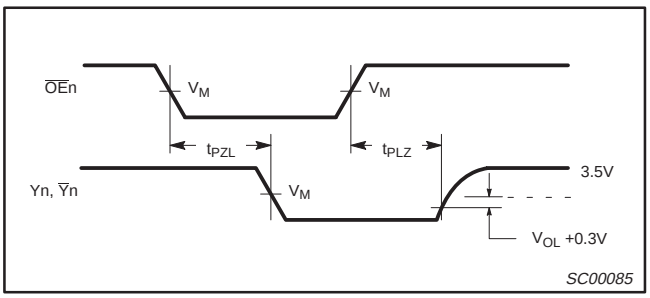
Waveform 1. Propagation Delay for Data and Select to Outputs



Waveform 2. Propagation Delay for Data and Select to Outputs

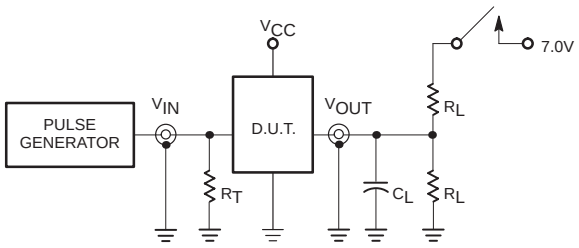


Waveform 3. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 4. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

TEST CIRCUIT AND WAVEFORMS



Test Circuit for 3-State Outputs

SWITCH POSITION

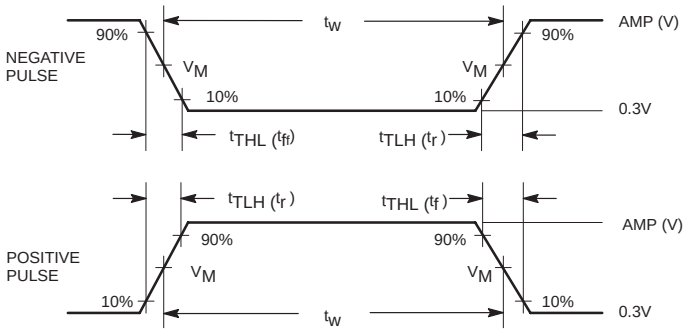
TEST	SWITCH
t_{PLZ}, t_{PZL}	closed
All other	open

DEFINITIONS:

R_L = Load resistor; see AC electrical characteristics for value.

C_L = Load capacitance includes jig and probe capacitance; see AC electrical characteristics for value.

R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

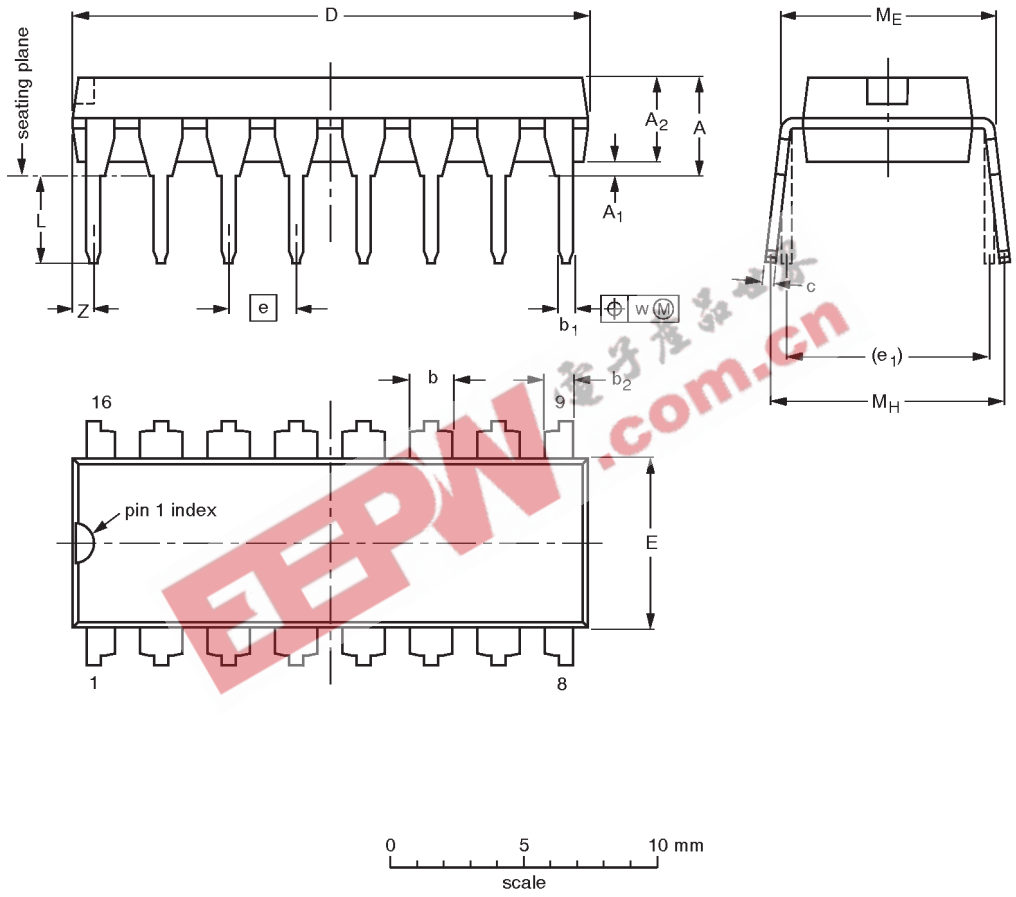


Input Pulse Definition

Family	INPUT PULSE REQUIREMENTS					
	Amplitude	V_M	Rep.Rate	t_w	t_{TLH}	t_{THL}
74ALS	3.5V	1.3V	1MHz	500ns	2.0ns	2.0ns

SC00072

DIP16: plastic dual in-line package; 16 leads (300 mil) **SOT38-4**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

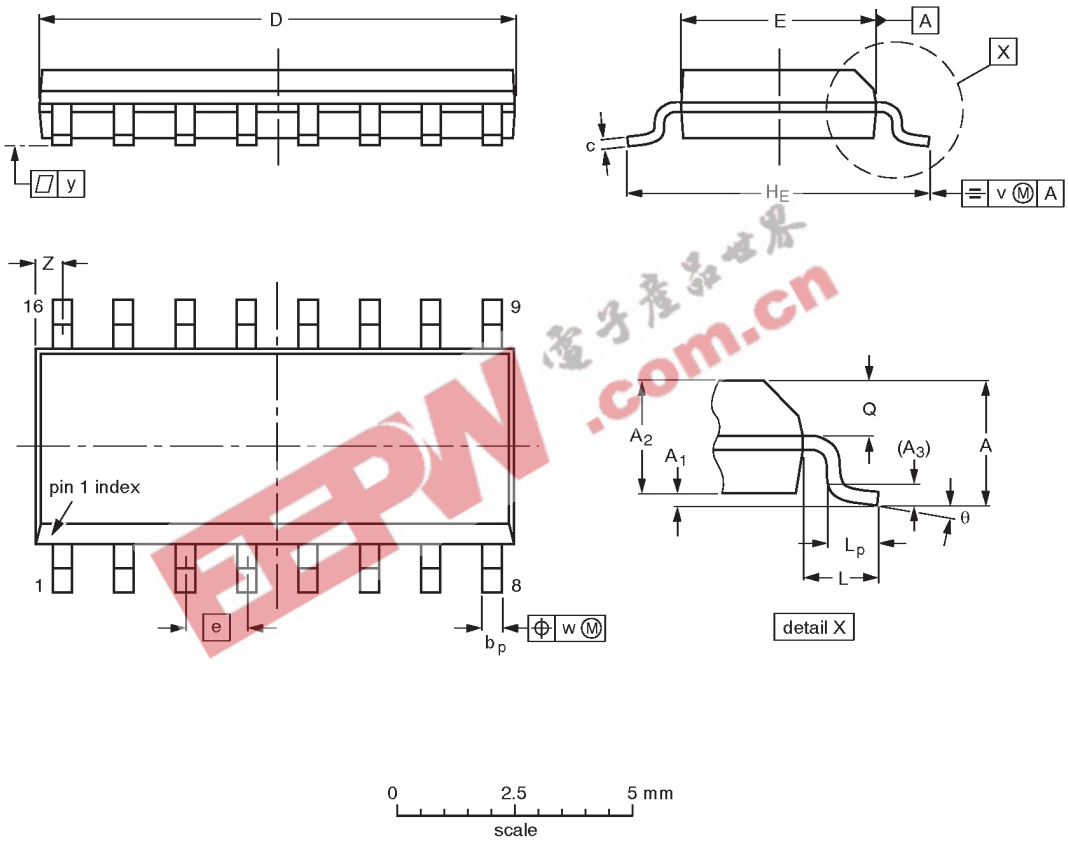
UNIT	A max.	A_1 min.	A_2 max.	b	b_1	b_2	c	D (1)	E (1)	e	e_1	L	M_E	M_H	w	Z (1) max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT38-4						~~92-11-17~~ 95-01-14

SO16: plastic small outline package; 16 leads; body width 3.9 mm **SOT109-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

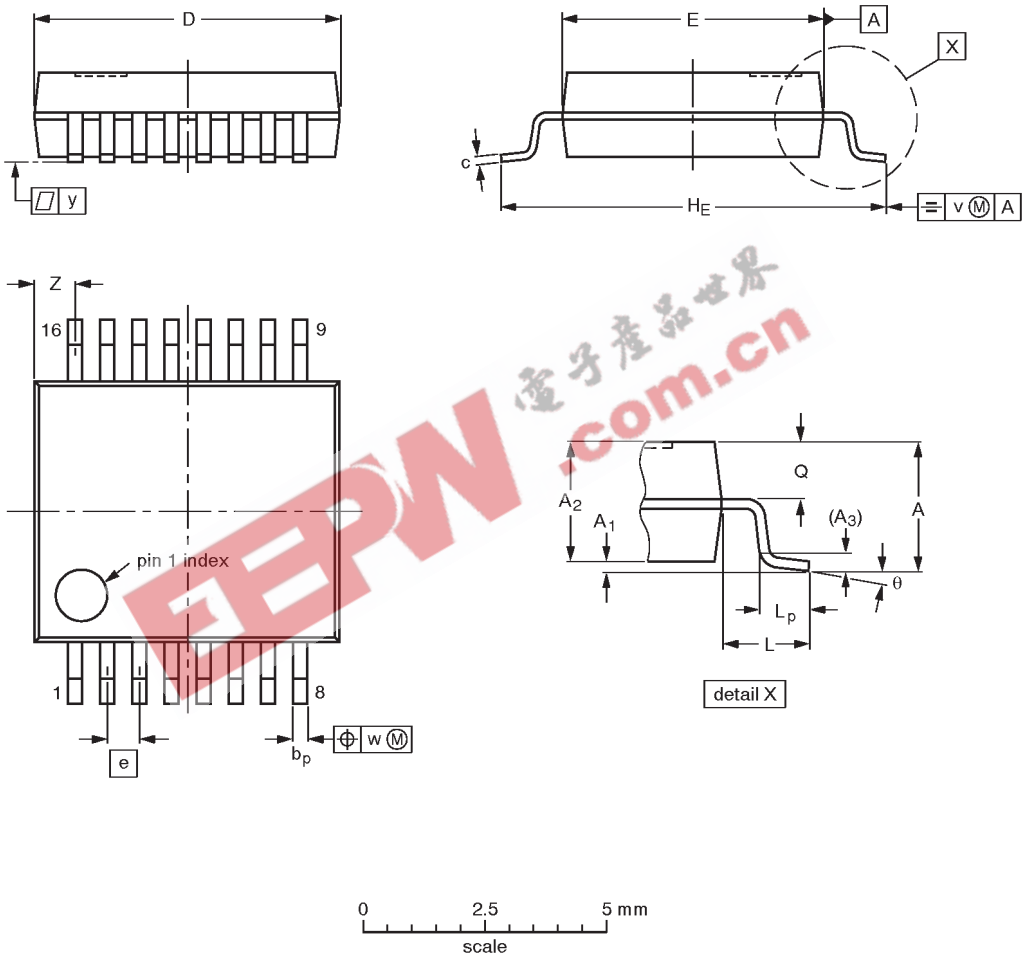
UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.0098 0.0039	0.057 0.049	0.01	0.019 0.014	0.0098 0.0075	0.39 0.38	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT109-1	076E07S	MS-012AC				~~91-08-13~~ 95-01-23

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm **SOT338-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (1)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT338-1		MO-150AC				~~94-01-14~~ 95-02-04

DEFINITIONS

Data Sheet Identification	Product Status	Definition
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product Specification	Full Production	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.

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